

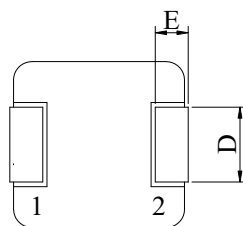
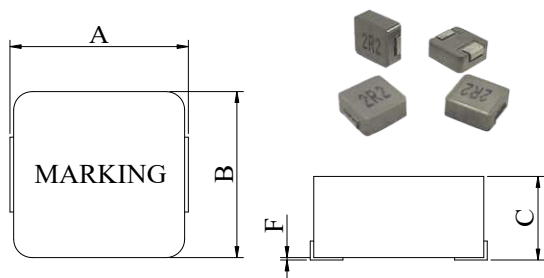
TOKO FDSD0630 alternatives

SMD Shielded Power Inductor

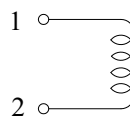
TOKO / Murata P.N.	BEC alternative	Inductance (μH)	DC Resistance ($\text{m}\Omega$)		DC Saturation Current (A)		Heat Rating Current (A)	
			Typ.	Max.	I sat Typ.	I sat Max.	I rms Typ.	I rms Max.
FDSD0630-H-R68M	> BEC-PMG63T-681MT	0.68	4.7	5.3	17	15	16	14.5
FDSD0630-H-1R0M	> BEC-PMG63T-102MT	1.00	6.7	7.4	15	13.5	12	11
FDSD0630-H-1R5N	> BEC-PMG63T-152MT	1.50	10.2	12	14	12	10	9
FDSD0630-H-2R2M	> BEC-PMG63T-222MT	2.20	13.5	15	10	9	8	7.5
FDSD0630-H-3R3M	> BEC-PMG63T-332MT	3.30	19	22	9.5	8.5	6.5	6
FDSD0630-H-4R7M	> BEC-PMG63T-472MT	4.70	28	33	6.5	5.5	5.5	5
FDSD0630-H-5R6M	> BEC-PMG63T-562MT	5.60	39	42	6	5.2	5.5	5
FDSD0630-H-6R8M	> BEC-PMG63T-682MT	6.80	43	50	6	5	4.5	4.2
FDSD0630-H-8R2M	> BEC-PMG63T-822MT	8.20	54	60	6	4.7	4.5	4
FDSD0630-H-100M	> BEC-PMG63T-103MT	10.00	62	68	5.5	4.5	4	3.5



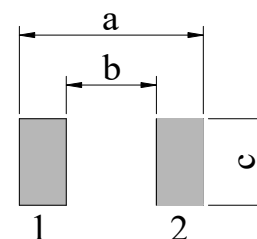
Dimensions & Shape : [mm]



Schematic



PAD LAYOUT



A	B	C	D	E	F	a	b	c
7.3 \pm 0.3	6.6 \pm 0.3	3.0 Max.	3.0 \pm 0.3	1.6 \pm 0.3	0 ~ 0.15 typ.	8.0	3.7	3.4

Note:

1. Marking : Inductance value and Date code.
2. The above PCB layout reference only, and recommend solder paste thickness at 0.15mm and above.

Product Identification :

PMG	63T	-	332	M	T		
Series name	External dimension L x W x T [mm]		Inductance Value		Inductance Tolerance	Packing	
Molding Type Iron Powder High Current Power Inductor	Code	Dimension	Code	Inductance value	Code	Tolerance	T \Rightarrow Tape & Reel B \Rightarrow Bulk with Trays
	63 T	7.3x6.6x3.0 Internal code	221	0.22 μH	J	\pm 5%	
			332	3.3 μH	K	\pm 10%	
			473	47 μH	L	\pm 15%	
			104	100 μH	M	\pm 20%	

- Operating temperature: -40 $^{\circ}\text{C}$ ~ +125 $^{\circ}\text{C}$ (including coil's self temperature rise).
- Storage temperature: -40 $^{\circ}\text{C}$ ~ +125 $^{\circ}\text{C}$.
- RoHS, REACH compliant, Halogen free available.

TOKO FDSD0630 alternatives



Full Inductance Range: 0.15 ~ 33.0 μ H

Electronial Characteristics :

TOKO / Murata P.N.	BEC alternative	Inductance (μ H) ① (μ H) ①	DC Resistance (m Ω)		DC Saturation Current ②		Heat Rating Current ③	
			Typ.	Max.	I sat (A) Typ.	I sat (A) Max.	I rms (A) Typ.	I rms (A) Max.
	BEC-PMG63T-151NT	0.15 \pm 30%	1.7	2.1	40	36	30	25
	BEC-PMG63T-221MT	0.22 \pm 20%	2	2.5	34	32	23	21
	BEC-PMG63T-331MT	0.33 \pm 20%	2.8	3.4	25	22	21	20
	BEC-PMG63T-361MT	0.36 \pm 20%	3.3	3.9	24	21	20	18
	PMG63T-471MT	0.47 \pm 20%	3.4	4	20	18	18	16
	BEC-PMG63T-561MT	0.56 \pm 20%	3.9	4.5	18	16	16.5	15
FDSD0630-H-R68M	> BEC-PMG63T-681MT	0.68 \pm 20%	4.7	5.3	17	15	16	14.5
	BEC-PMG63T-821MT	0.82 \pm 20%	5.4	6	16	14	14	13
FDSD0630-H-1R0M	> BEC-PMG63T-102MT	1.0 \pm 20%	6.7	7.4	15	13.5	12	11
	BEC-PMG63T-122MT	1.2 \pm 20%	7.7	10	14	12.5	10	9.5
FDSD0630-H-1R5N	> BEC-PMG63T-152MT	1.5 \pm 20%	10.2	12	14	12	10	9
	BEC-PMG63T-182MT	1.8 \pm 20%	10.9	13	12	10	9	8
FDSD0630-H-2R2M	> BEC-PMG63T-222MT	2.2 \pm 20%	13.5	15	10	9	8	7.5
	BEC-PMG63T-272MT	2.7 \pm 20%	17.3	20	9.8	8.8	7.2	7
FDSD0630-H-3R3M	> BEC-PMG63T-332MT	3.3 \pm 20%	19	22	9.5	8.5	6.5	6
FDSD0630-H-4R7M	> BEC-PMG63T-472MT	4.7 \pm 20%	28	33	6.5	5.5	5.5	5
FDSD0630-H-5R6M	> BEC-PMG63T-562MT	5.6 \pm 20%	39	42	6	5.2	5.5	5
FDSD0630-H-6R8M	> BEC-PMG63T-682MT	6.8 \pm 20%	43	50	6	5	4.5	4.2
FDSD0630-H-8R2M	> BEC-PMG63T-822MT	8.2 \pm 20%	54	60	6	4.7	4.5	4
FDSD0630-H-100M	> BEC-PMG63T-103MT	10.0 \pm 20%	62	68	5.5	4.5	4	3.5
	BEC-PMG63T-153MT	15.0 \pm 20%	110	140	4.5	4	3	2.5
	BEC-PMG63T-223MT	22.0 \pm 20%	150	190	3	2.5	2.5	2
	BEC-PMG63T-333MT	33.0 \pm 20%	215	258	2.5	2	2.1	1.8

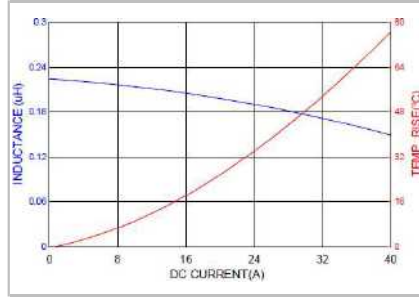
1. Inductance measured at: 100kHz, 1Vrms, 0Adc, on an Agilent/HP4284A LCR meter or equivalent.
2. Saturation current (Isat) : DC current at which the inductance drops approximately 30% from its value without current.
3. Heat rating current (Irms): DC current that causes the temperature rise($\Delta t=40^{\circ}\text{C}$) from 25°C ambient.
4. The part temperature (ambient + temperature rise) should not exceed 125°C under worst case.
5. All test data referenced to 25°C ambient, unless otherwise specified.
6. Rated current: Isat or Irms, whichever is smaller.

Typical Performance Curves:

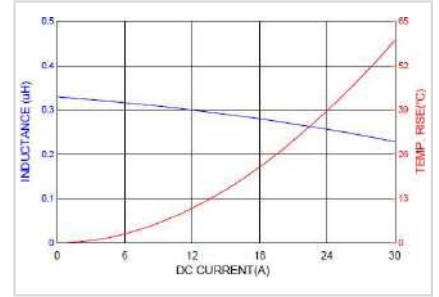
PMG63T-151N



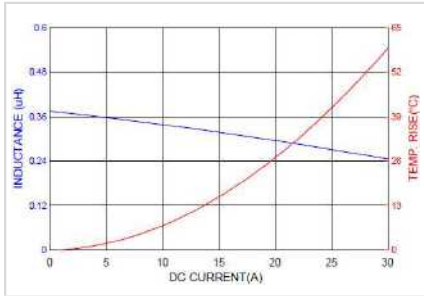
PMG63T-221N



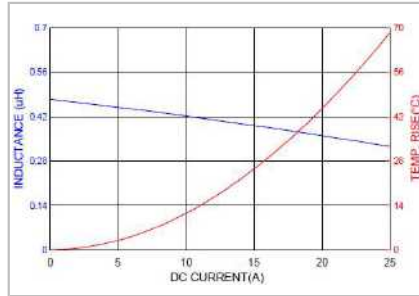
PMG63T-331M



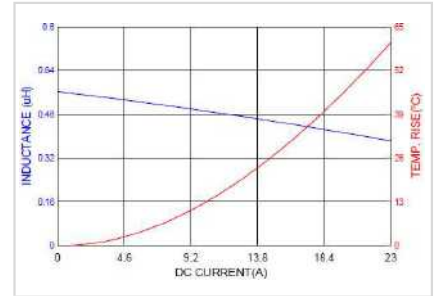
PMG63T-361M



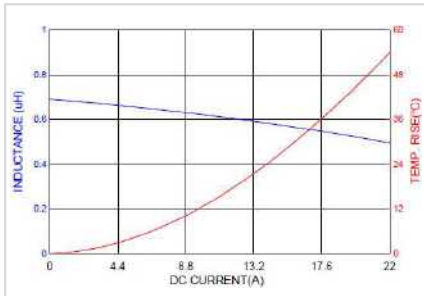
PMG63T-471M



PMG63T-561M



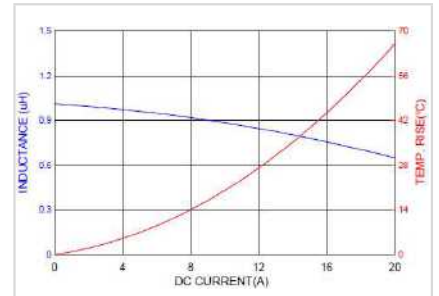
PMG63T-681M



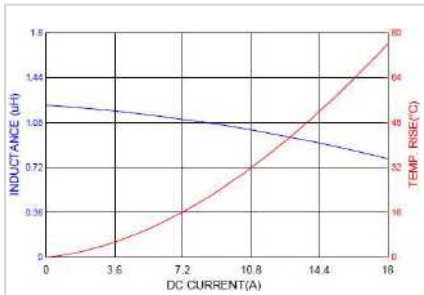
PMG63T-821M



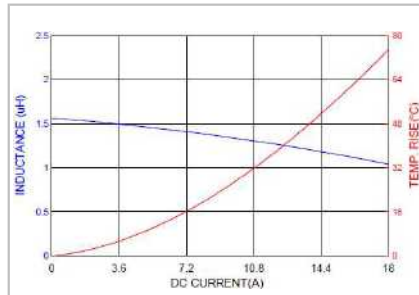
PMG63T-102M



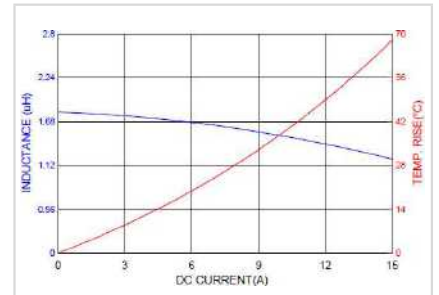
PMG63T-122M



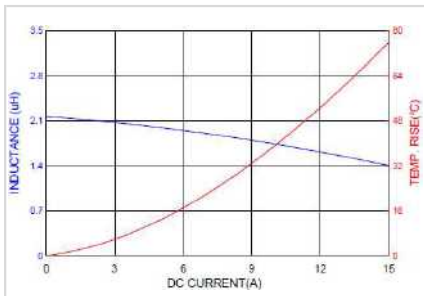
PMG63T-152M



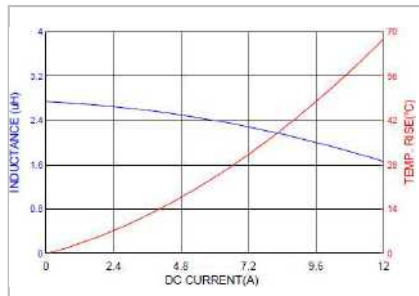
PMG63T-182M



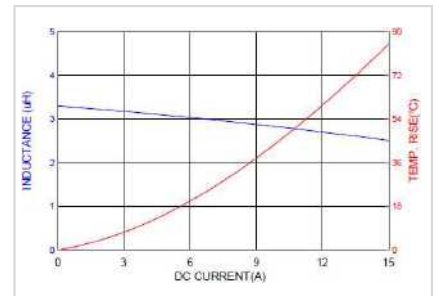
PMG63T-222M



PMFG63T-272M

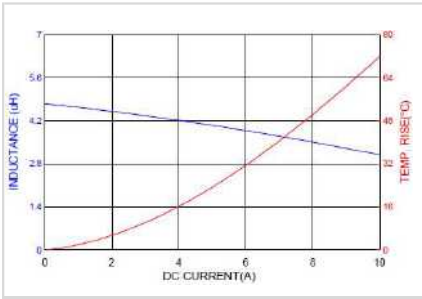


PMG63T-332M

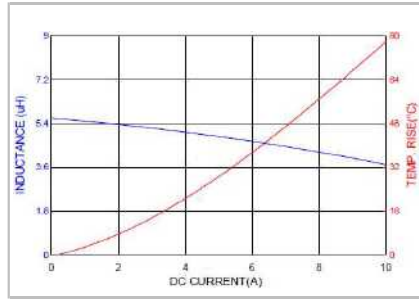


Typical Performance Curves:

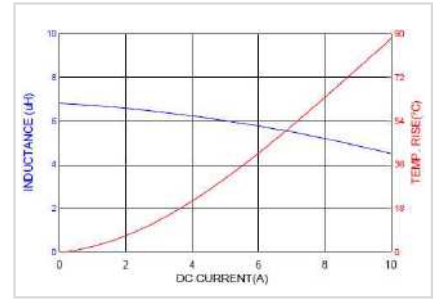
PMG63T-472M



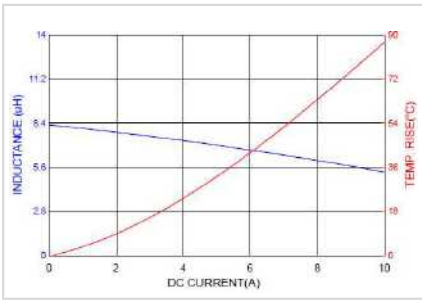
PMG63T-562M



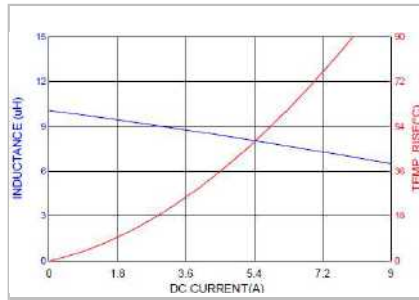
PMG63T-682M



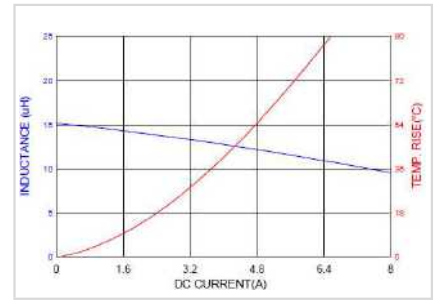
PMG63T-822M



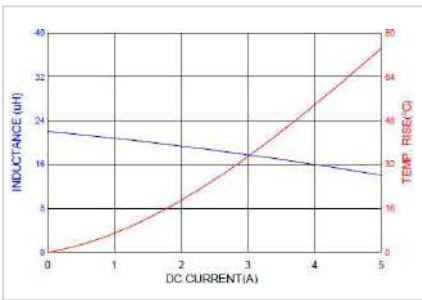
PMG63T-103M



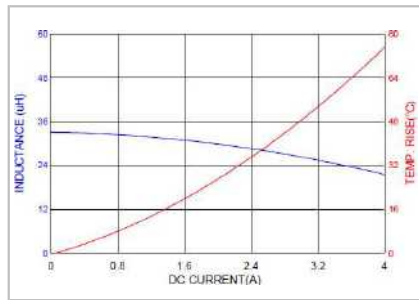
PMF63T-153M



PMG63T-223M

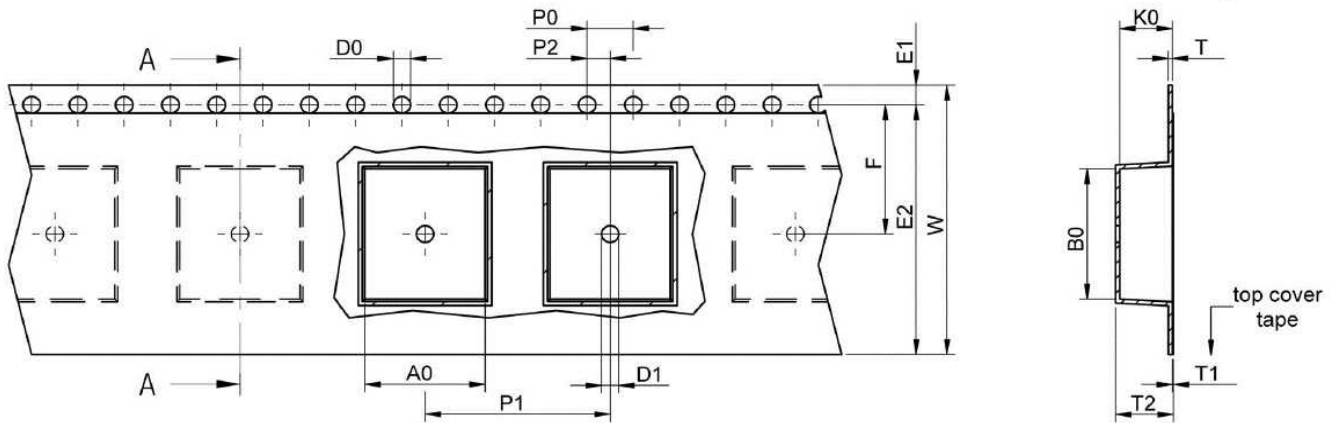


PMG63T-333M

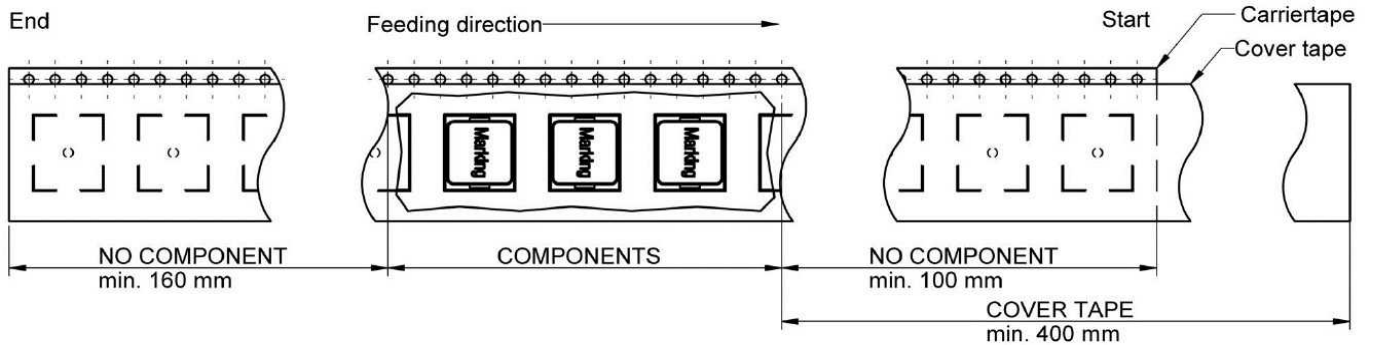


Packaging Specification - Tape and Reel [mm]:

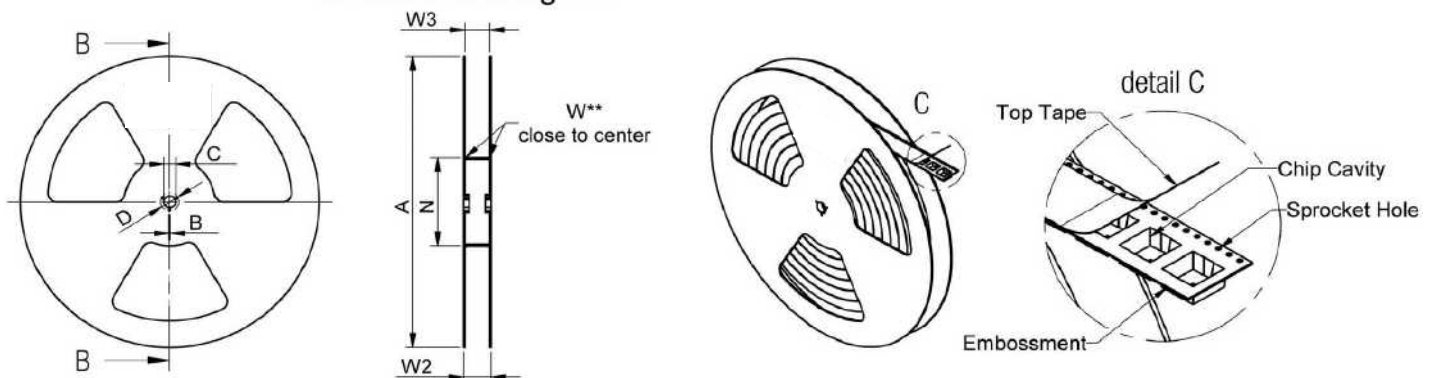
sectional drawing A-A



Tolerance Size	A0	B0	W	P1	T	T1	T2	K0	D0	D1	E1	E2	F	P0	P2	Tape	Packaging unit
		typ.	typ.	±0.3	±0.1	max.	min.	ref.	typ.	+0.1	min.	±0.1	min.	±0.1	±0.1	±0.1	
PMG63T	7.0	7.5	16.0	12.0	0.4	0.1	3.4	3.2	1.5	1.5	1.75	14.2	7.5	4.0	2.0	Ploystyrene	1000



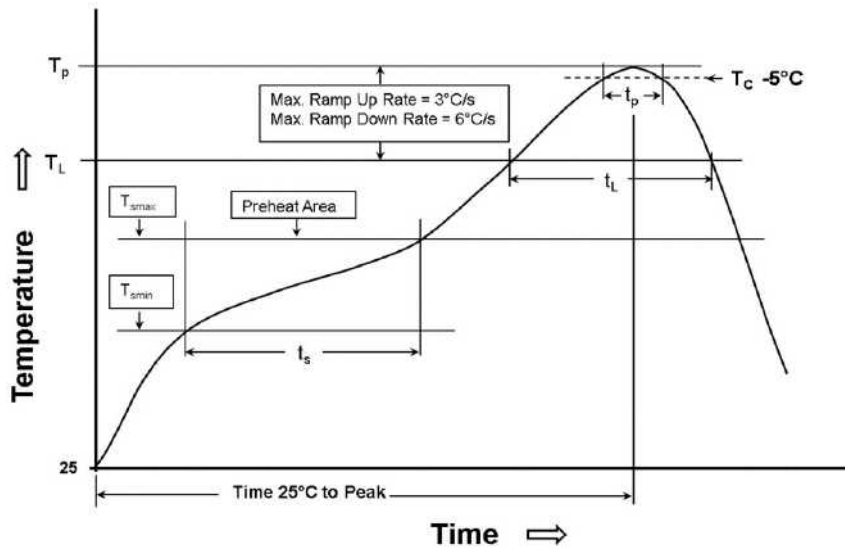
sectional drawing B-B



PMG63T Tape width	A	B	C	D	N	W2	W3
W = 16 mm	330	1.50 min.	13.0 ± 1.0	21.0 ± 0.8	100	20.0 ± 2.0	16.0 ± 0.5

Recommend Soldering Specifications:

Classification Reflow Profile for SMT components:



Classification Reflow Profile :

Profile Feature	Pb-Free Assembly
Preheat	
- Temperature Min(T_{smin})	150°C
- Temperature Max(T_{smax})	200°C
- Time(t_s) from(T_{smin} to T_{smax})	60-120 seconds
Ramp-up rate (T_L to T_p)	3°C / second max.
Liquidous temperature (T_L)	217°C
Time(t_L) maintained above T_L	60-150 seconds
Time within 5°C of actual peak temperature (t_p)	20-30 seconds
Ramp-downrate(T_p to T_L)	6°C / second max.
Time 25°C to peak temperature	8 minutes max.

Pack Classification Reflow Temperature :

	Package Thickness	Volume (mm^3) < 350	Volume (mm^3) 350-2000	Volume (mm^3) > 2000
Pb-Free Assembly	< 1.6 mm	260 °C	260 °C	260 °C
Pb-Free Assembly	1.6 mm - 2.5mm	260 °C	250 °C	245 °C
Pb-Free Assembly	\geq 2.5 mm	260 °C	245 °C	245 °C